

**CET**

# CEP02N9/CEB02N9 CEF02N9

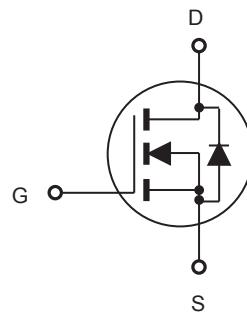
## N-Channel Enhancement Mode Field Effect Transistor

PRELIMINARY

### FEATURES

| Type    | V <sub>DSS</sub> | R <sub>DS(ON)</sub> | I <sub>D</sub>    | @V <sub>GS</sub> |
|---------|------------------|---------------------|-------------------|------------------|
| CEP02N9 | 900V             | 6.8Ω                | 2.6A              | 10V              |
| CEB02N9 | 900V             | 6.8Ω                | 2.6A              | 10V              |
| CEF02N9 | 900V             | 6.8Ω                | 2.6A <sup>d</sup> | 10V              |

- Super high dense cell design for extremely low R<sub>DS(ON)</sub>.
- High power and current handing capability.
- Lead free product is acquired.



### ABSOLUTE MAXIMUM RATINGS

 T<sub>C</sub> = 25°C unless otherwise noted

| Parameter  | Symbol                            | Limit       |                                      | Units     |
|--|-----------------------------------|-------------|--------------------------------------|-----------|
|  |                                   | TO-220/263  | TO-220F                              |           |
| Drain-Source Voltage   | V <sub>DS</sub>                   | 900         |                                      | V         |
| Gate-Source Voltage  | V <sub>GS</sub>                   | ±30         |                                      | V         |
| Drain Current-Continuous @ T <sub>C</sub> = 25°C<br>@ T <sub>C</sub> = 100°C | I <sub>D</sub>                    | 2.6<br>1.9  | 2.6 <sup>d</sup><br>1.9 <sup>d</sup> | A         |
| Drain Current-Pulsed <sup>a</sup>  | I <sub>DM</sub> <sup>e</sup>      | 10.4        | 10.4 <sup>d</sup>                    | A         |
| Maximum Power Dissipation @ T <sub>C</sub> = 25°C<br>- Derate above 25°C     | P <sub>D</sub>                    | 125<br>0.83 | 47<br>0.3                            | W<br>W/°C |
| Operating and Store Temperature Range  | T <sub>J</sub> , T <sub>stg</sub> | -55 to 175  |                                      | °C        |

### Thermal Characteristics

| Parameter                               | Symbol           | Limit |      | Units |
|---|------------------|-------|------|-------|
| Thermal Resistance, Junction-to-Case    | R <sub>θJC</sub> | 1.2   | 3.2  | °C/W  |
| Thermal Resistance, Junction-to-Ambient | R <sub>θJA</sub> | 62.5  | 62.5 | °C/W  |

This is preliminary information on a new product in development now .  
Details are subject to change without notice .

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<http://www.cetsemi.com>



# CEP02N9/CEB02N9 CEF02N9

## Electrical Characteristics $T_C = 25^\circ\text{C}$ unless otherwise noted

| Parameter   | Symbol                     | Test Condition   | Min | Typ | Max  | Units         |
|---|----------------------------|--|-----|-----|------|---------------|
| <b>Off Characteristics</b>                                    |                            |  |     |     |      |               |
| Drain-Source Breakdown Voltage                                | $\text{BV}_{\text{DSS}}$   | $V_{\text{GS}} = 0\text{V}, I_{\text{D}} = 250\mu\text{A}$   | 900 |     |      | V             |
| Zero Gate Voltage Drain Current                               | $I_{\text{DSS}}$           | $V_{\text{DS}} = 900\text{V}, V_{\text{GS}} = 0\text{V}$   |     |     | 25   | $\mu\text{A}$ |
| Gate Body Leakage Current, Forward                            | $I_{\text{GSSF}}$          | $V_{\text{GS}} = 30\text{V}, V_{\text{DS}} = 0\text{V}$  |     |     | 100  | nA            |
| Gate Body Leakage Current, Reverse                            | $I_{\text{GSSR}}$          | $V_{\text{GS}} = -30\text{V}, V_{\text{DS}} = 0\text{V}$   |     |     | -100 | nA            |
| <b>On Characteristics<sup>b</sup></b>                         |                            |  |     |     |      |               |
| Gate Threshold Voltage  | $V_{\text{GS}(\text{th})}$ | $V_{\text{GS}} = V_{\text{DS}}, I_{\text{D}} = 250\mu\text{A}$   | 2   |     | 4    | V             |
| Static Drain-Source On-Resistance                             | $R_{\text{DS}(\text{on})}$ | $V_{\text{GS}} = 10\text{V}, I_{\text{D}} = 1.3\text{A}$   |     | 5.3 | 6.8  | $\Omega$      |
| <b>Dynamic Characteristics<sup>c</sup></b>                    |                            |  |     |     |      |               |
| Input Capacitance   | $C_{\text{iss}}$           | $V_{\text{DS}} = 25\text{V}, V_{\text{GS}} = 0\text{V}, f = 1.0 \text{ MHz}$                                     |     | 690 |      | pF            |
| Output Capacitance  | $C_{\text{oss}}$           |  |     | 70  |      | pF            |
| Reverse Transfer Capacitance                                  | $C_{\text{rss}}$           |  |     | 15  |      | pF            |
| <b>Switching Characteristics<sup>c</sup></b>                  |                            |  |     |     |      |               |
| Turn-On Delay Time  | $t_{\text{d}(\text{on})}$  | $V_{\text{DD}} = 450\text{V}, I_{\text{D}} = 2.2\text{A}, V_{\text{GS}} = 10\text{V}, R_{\text{GEN}} = 25\Omega$ |     | 20  | 40   | ns            |
| Turn-On Rise Time   | $t_r$                      |  |     | 34  | 68   | ns            |
| Turn-Off Delay Time   | $t_{\text{d}(\text{off})}$ |  |     | 44  | 88   | ns            |
| Turn-Off Fall Time  | $t_f$                      |  |     | 28  | 56   | ns            |
| Total Gate Charge   | $Q_g$                      | $V_{\text{DS}} = 720\text{V}, I_{\text{D}} = 2.2\text{A}, V_{\text{GS}} = 10\text{V}$                            |     | 16  | 20   | nC            |
| Gate-Source Charge  | $Q_{\text{gs}}$            |  |     | 3   |      | nC            |
| Gate-Drain Charge   | $Q_{\text{gd}}$            |  |     | 7   |      | nC            |
| <b>Drain-Source Diode Characteristics and Maximum Ratings</b> |                            |  |     |     |      |               |
| Drain-Source Diode Forward Current                            | $I_{\text{S}}$             |  |     |     | 2    | A             |
| Drain-Source Diode Forward Voltage <sup>b</sup>               | $V_{\text{SD}}$            | $V_{\text{GS}} = 0\text{V}, I_{\text{S}} = 2\text{A}$  |     |     | 1.2  | V             |

Notes :

a.Repetitive Rating : Pulse width limited by maximum junction temperature .

b.Pulse Test : Pulse Width  $\leq 300\mu\text{s}$ . Duty Cycle  $\leq 2\%$  .<sup>d</sup>

c.Guaranteed by design, not subject to production testing.<sup>e</sup>

d.Limited only by maximum temperature allowed .

e.Pulse width limited by safe operating area .

**CEP**

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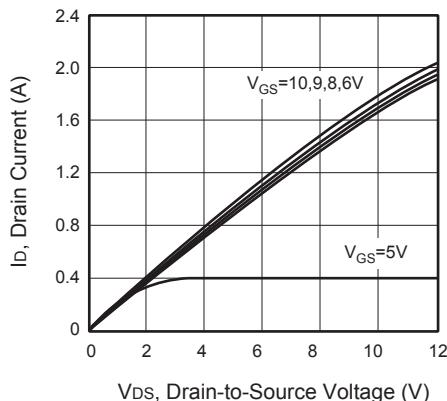


Figure 1. Output Characteristics

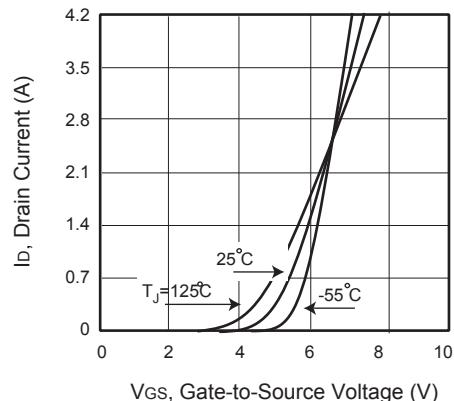


Figure 2. Transfer Characteristics

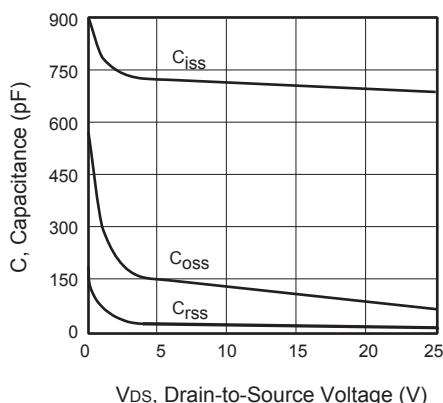


Figure 3. Capacitance

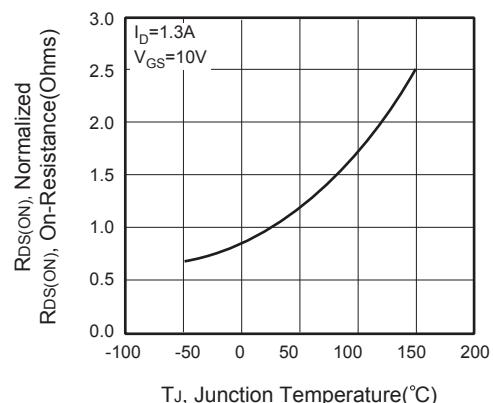


Figure 4. On-Resistance Variation with Temperature

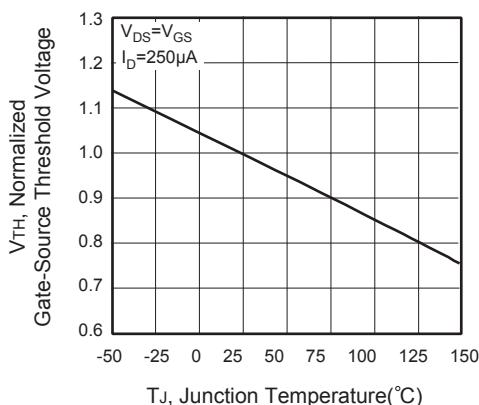


Figure 5. Gate Threshold Variation with Temperature

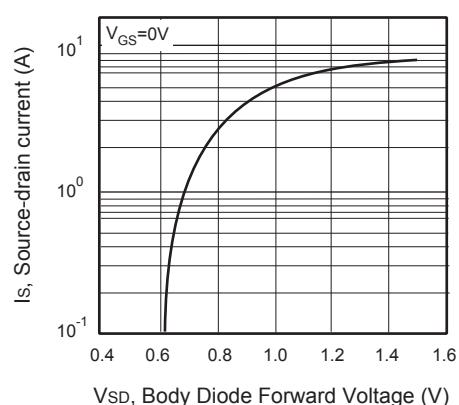


Figure 6. Body Diode Forward Voltage Variation with Source Current

CEP

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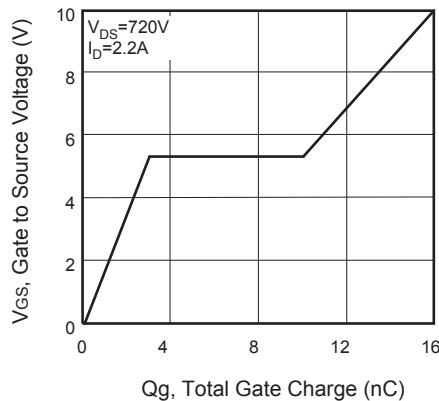


Figure 7. Gate Charge

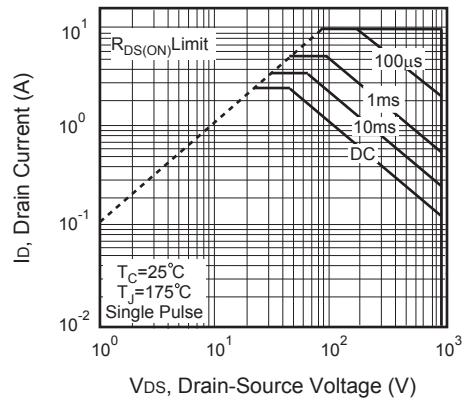


Figure 8. Maximum Safe Operating Area



Figure 9. Switching Test Circuit



Figure 10. Switching Waveforms

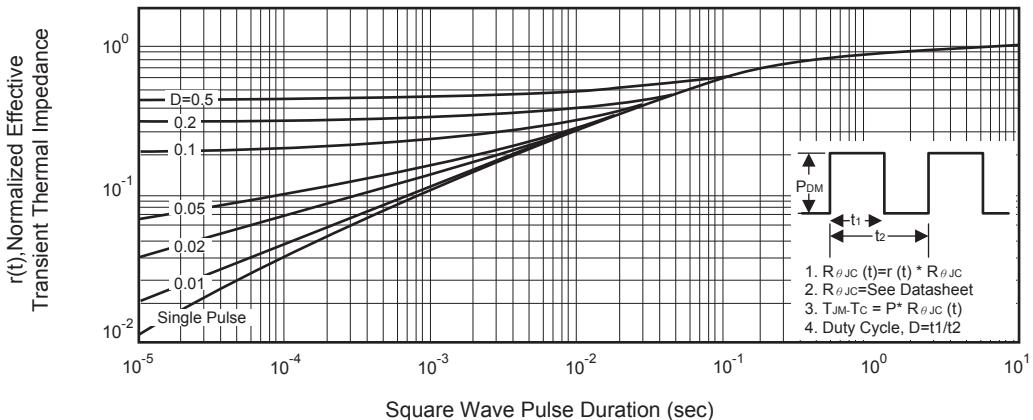


Figure 11. Normalized Thermal Transient Impedance Curve